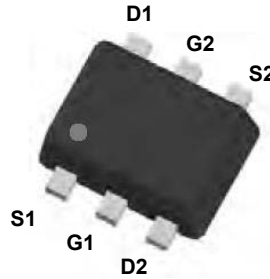
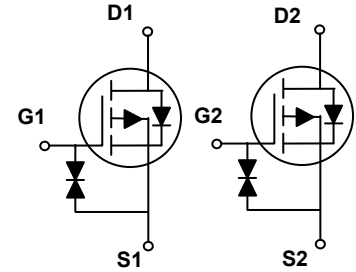


Main Product Characteristics

$V_{(BR)DSS}$	-20V
$R_{DS(ON)}$	600mΩ
I_D	-400mA



SOT-563



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for notebook, load switch, networking and hand-held devices
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The SSF2219Y utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	±8	V
Drain Current-Continuous ($T_c=25^\circ\text{C}$)	I_D	-400	mA
Drain Current-Continuous ($T_c=100^\circ\text{C}$)		-250	
Drain Current-Pulsed ¹	I_{DM}	-1.6	A
Power Dissipation ($T_c=25^\circ\text{C}$)	P_D	312	mW
Power Dissipation-Derate above 25°C		2.5	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	400	°C/W
Operating Junction Temperature Range	T_J	-55 To +150	°C
Storage Temperature Range	T_{STG}	-55 To +150	°C

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On/Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=-1mA$	-	-0.01	-	$V/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V,$ $T_J=25^\circ\text{C}$	-	-	-1	μA
		$V_{DS}=-16V, V_{GS}=0V,$ $T_J=125^\circ\text{C}$	-	-	-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 4.5V, V_{DS}=0V$	-	-	± 2	μA
		$V_{GS}=\pm 8V, V_{DS}=0V$	-	-	± 15	μA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-0.3A$	-	440	600	m Ω
		$V_{GS}=-2.5V, I_D=-0.2A$	-	610	850	
		$V_{GS}=-1.8V, I_D=-0.1A$	-	810	1200	
		$V_{GS}=-1.5V, I_D=-0.1A$	-	1020	1600	
		$V_{GS}=-1.2V, I_D=-0.1A$	-	1800	3000	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-0.3	-0.6	-1.0	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		-	3	-	$mV/^\circ\text{C}$
Dynamic and Switching Characteristics						
Total Gate Charge ^{2,3}	Q_g	$V_{DS}=-10V, I_D=-0.2A$ $V_{GS}=-4.5V$	-	1	2	nC
Gate-Source Charge ^{2,3}	Q_{gs}		-	0.28	0.5	
Gate-Drain Charge ^{2,3}	Q_{gd}		-	0.18	0.4	
Turn-On Delay Time ^{2,3}	$t_{d(on)}$	$V_{DD}=-10V, R_G=10\Omega$ $V_{GS}=-4.5V, I_D=-0.2A$	-	8	16	nS
Rise Time ^{2,3}	t_r		-	5.2	10	
Turn-Off Delay Time ^{2,3}	$t_{d(off)}$		-	30	60	
Fall Time ^{2,3}	t_f		-	18	36	
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V,$ $F=1MHz$	-	40	78	pF
Output Capacitance	C_{oss}		-	15	30	
Reverse Transfer Capacitance	C_{rss}		-	6.5	13	
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0V,$	-	-	-0.4	A
Pulsed Source Current	I_{SM}	Force Current	-	-	-0.8	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-0.2A,$ $T_J=25^\circ\text{C}$	-	-	-1	V

Notes:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

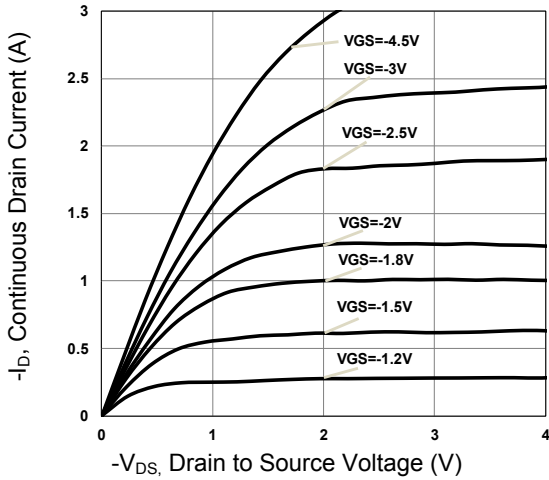


Figure 1. Typical Output Characteristics

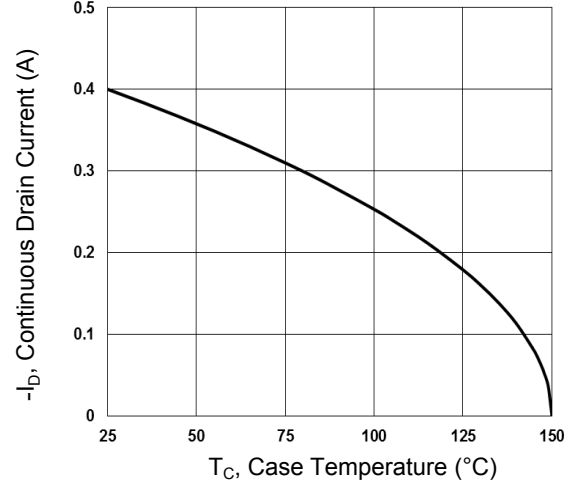


Figure 2. Continuous Drain Current vs. T_C

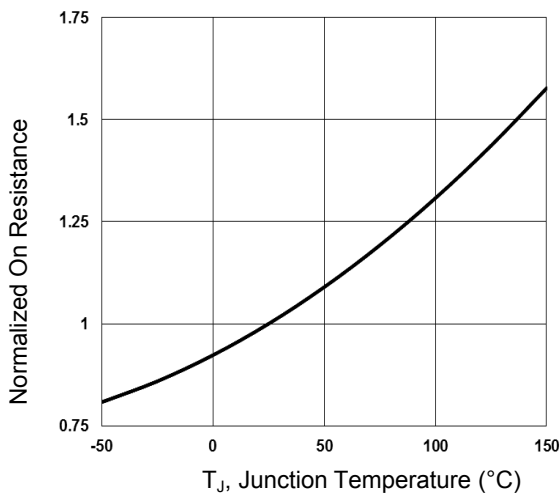


Figure 3. Normalized $R_{DS(ON)}$ vs. T_J

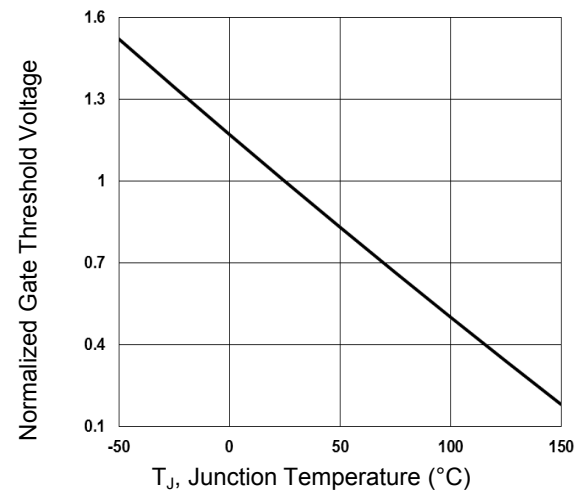


Figure 4. Normalized V_{th} vs. T_J

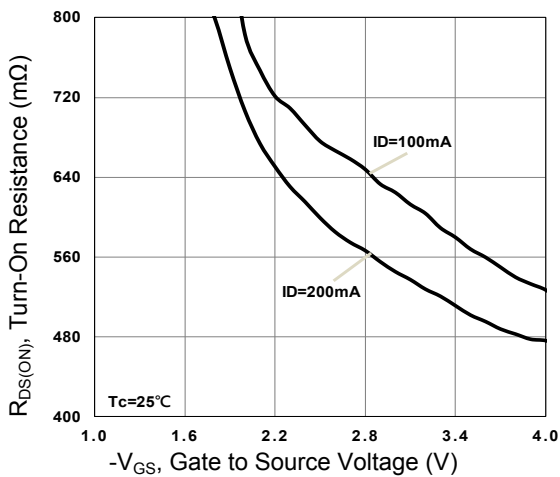


Figure 5. Turn-On Resistance vs. V_{GS}

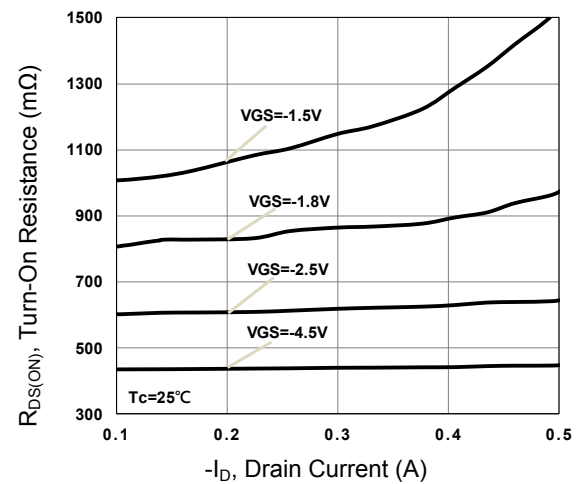


Figure 6. Turn-On Resistance vs. I_D

Typical Electrical and Thermal Characteristic Curves

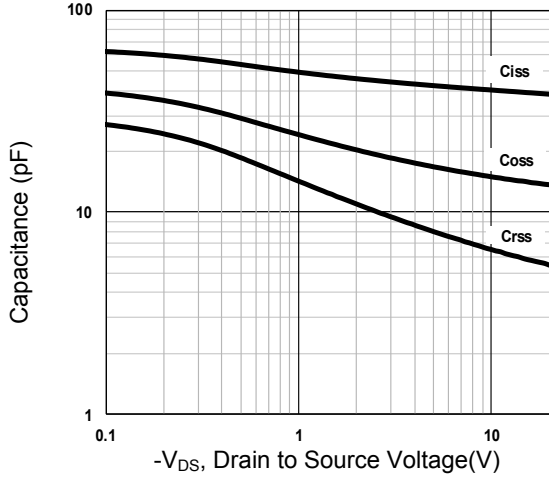


Figure 7. Capacitance Characteristics

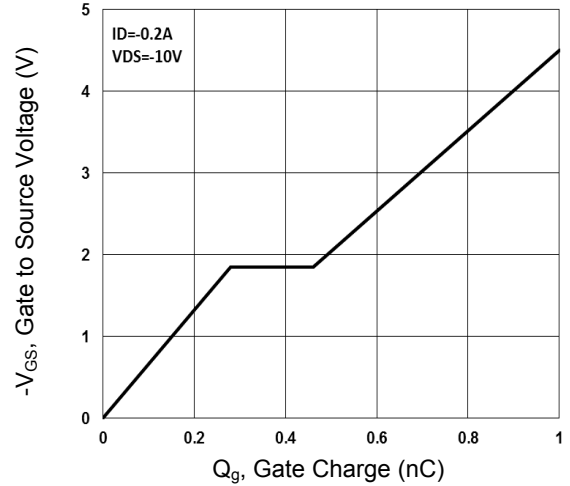


Figure 8. Gate Charge Characteristics

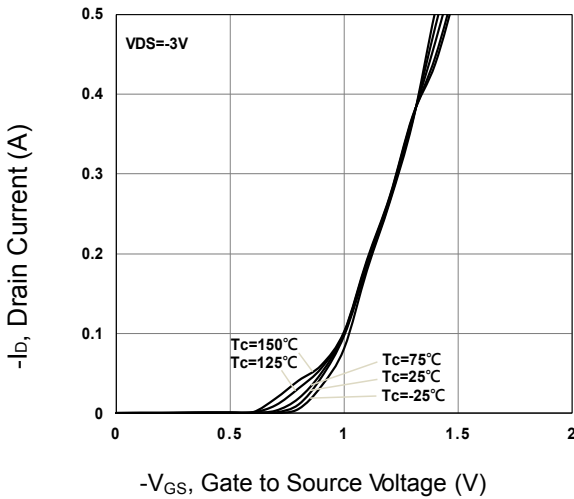


Figure 9. Transfer Characteristics

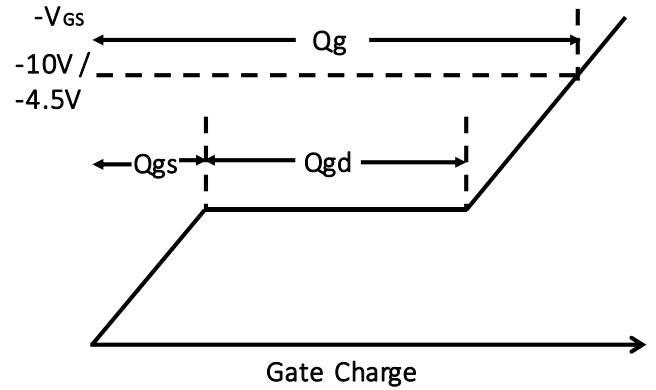


Figure 10. Gate Charge Waveform

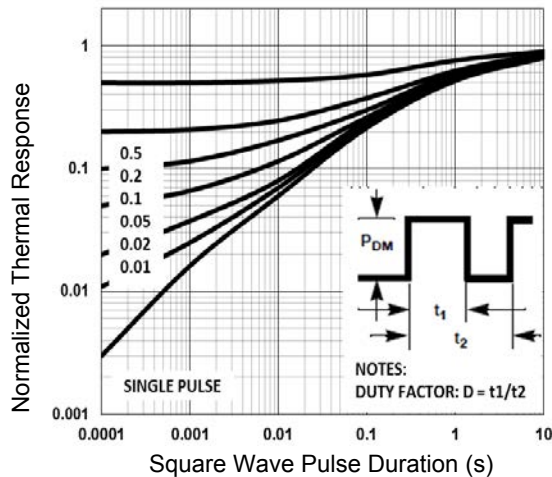


Figure 11. Normalized Transient Impedance

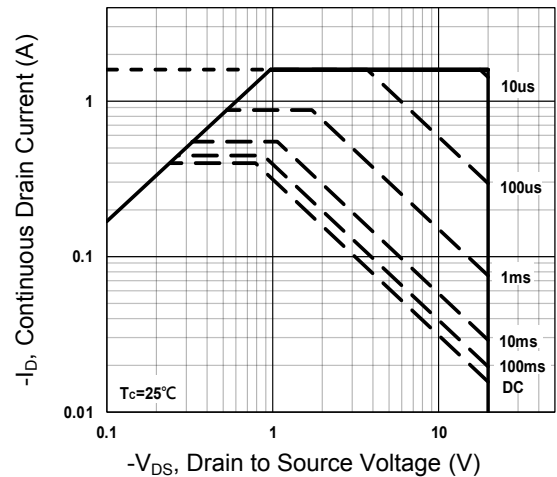
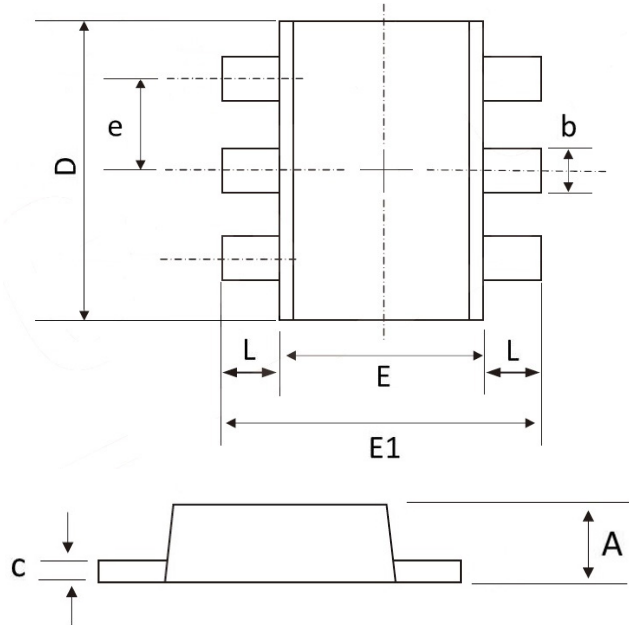


Figure 12. Maximum Safe Operation Area

Package Outline Dimensions (SOT-563)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.500	0.630	0.020	0.025
b	0.150	0.300	0.006	0.012
c	0.100	0.180	0.004	0.007
D	1.500	1.700	0.059	0.067
E	1.100	1.250	0.043	0.049
E1	1.550	1.700	0.061	0.067
e	0.500 BSC		0.020 BSC	
L	0.100	0.300	0.004	0.012

Order Information

Device	Package	Marking	Carrier	Quantity
SSF2219Y	SOT-563	E	Tape & Reel	3,000pcs / Reel